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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Vikas Gupta

Serial No.: 10/661,035

Filing Date: 09/15/03

Title: Thin Film Shape Memory Alloy
Actuated Microrelay

Group Art Unit: 2832

Examiner: Lincoln Donovan

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450, on Wed, Apr 12, 2006

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Mail Stop No Fee Patent Application
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

STATUS ENQUIRY

Sir:

Applicant enquires as to the status of the subject application. In particular, Applicant enquires as to when a Notice Of Allowance And Issue Fee Due can be expected.

Respectfully submitted,

Date: Wed, Apr 12, 2006

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